## Si4835DDY

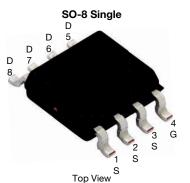
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**Vishay Siliconix** 

S

P-Channel MOSFET

G



Top View					
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-30				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -10 V	0.018				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -4.5 V	0.030				
Q <sub>g</sub> typ. (nC)	22				
I <sub>D</sub> (A) <sup>d</sup>	-13				
Configuration	Single				

#### **FEATURES**

P-Channel 30 V (D-S) MOSFET

- TrenchFET<sup>®</sup> power MOSFET
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Load switches
- Notebook PCs
- Desktop PCs



COMPLIANT HALOGEN FREE

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#### ORDERING INFORMATION

Package	SO-8		
Lead (Pb)-free	Si4835DDY-T1-E3		
Lead (Pb)-free and halogen-free	Si4835DDY-T1-GE3		

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_A = 25 \text{ °C}$ , unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	-30	V	
Gate-source voltage		V <sub>GS</sub>	±25	v	
	T <sub>C</sub> = 25 °C		-13		
Continuous drain surrent (T 150 °C)	T <sub>C</sub> = 70 °C	] , [	-10.5		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C		-8.7 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C	1	-7.7 <sup>a, b</sup>		
Pulsed drain current			-50	A	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C	1	-4.6		
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2 <sup>a, b</sup>		
Avalanche current		I <sub>AS</sub>	-20		
Single-pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C	5	5.6		
Maximum power dissipation	T <sub>C</sub> = 70 °C		3.6	10/	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>a, b</sup>	- W	
	T <sub>A</sub> = 70 °C	1	1.6 <sup>a, b</sup>		
Operating junction and storage temperature range	•	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	

#### THERMAL RESISTANCE RATINGS SYMBOL TYPICAL MAXIMUM PARAMETER UNIT Maximum junction-to-ambient a, c t ≤ 10 s $R_{thJA}$ 39 50 °C/W Maximum junction-to-foot Steady state 18 22 R<sub>thJF</sub>

Notes

a. Surface mounted on 1" x 1" FR4 board

b. t = 10 s

c. Maximum under steady state conditions is 85 °C/W

d. Based on  $T_C = 25 \ ^{\circ}C$ 

S09-0136-Rev. B, 02-Feb-09

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## Si4835DDY

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-30	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	-31	-	mV/°C
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	5.5	-	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-1	-	-3	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 25 V$	-	-	± 100	nA
7		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	<u>,</u>
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	-5	μA
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	-30	-	-	А
		V <sub>GS</sub> = -10 V, I <sub>D</sub> = -10 A	-	0.0140	0.0180	Ω
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -7 A	-	0.0245	0.0300	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -10 A	-	23	-	S
Dynamic <sup>b</sup>	• 					
Input capacitance	C <sub>iss</sub>		-	1960	-	pF
Output capacitance	C <sub>oss</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	380	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	325	-	
Table also also a	<u> </u>	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -10 \text{ A}$ $V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -10 \text{ A}$	-	43	65	
Total gate charge	Qg		-	22	33	
Gate-source charge	Q <sub>gs</sub>		-	6	-	nC
Gate-drain charge	Q <sub>gd</sub>		-	11	-	1
Gate resistance	R <sub>g</sub>	f = 1 MHz	0.3	1.3	2.5	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	11	22	
Rise time	tr	$V_{DD}$ = -15 V, $R_L$ = 3 $\Omega$	-	13	25	
Turn-off delay time	t <sub>d(off)</sub>	$I_D\cong$ -5 A, $V_{GEN}$ = -10 V, $R_g$ = 1 $\Omega$	-	32	50	
Fall time	t <sub>f</sub>		-	9	18	
Turn-on delay time	t <sub>d(on)</sub>		-	44	70	ns
Rise time	t <sub>r</sub>	$V_{DD}$ = -15 V, $R_L$ = 3 $\Omega$	-	100	160	]
Turn-off delay time	t <sub>d(off)</sub>	$I_D\cong$ -5 A, $V_{GEN}$ = -4.5 V, $R_g$ = 1 $\Omega$	-	28	50	
Fall time	t <sub>f</sub>		-	15	30	
Drain-Source Body Diode Characteris	tics					
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-4.6	^
Pulse diode forward current	I <sub>SM</sub>		-	-	-50	A
Body diode voltage	V <sub>SD</sub>	$I_{\rm S} = -2$ A, $V_{\rm GS} = 0$ V	-	-0.75	-1.2	V
Body diode reverse recovery time	t <sub>rr</sub>		-	28	45	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = -2 A, di/dt = 100 A/μs,	-	20	40	nC
Reverse recovery fall time	t <sub>a</sub>	T <sub>J</sub> = 25 °C	-	13	-	
Reverse recovery rise time	t <sub>b</sub>		-	15	-	ns

#### Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

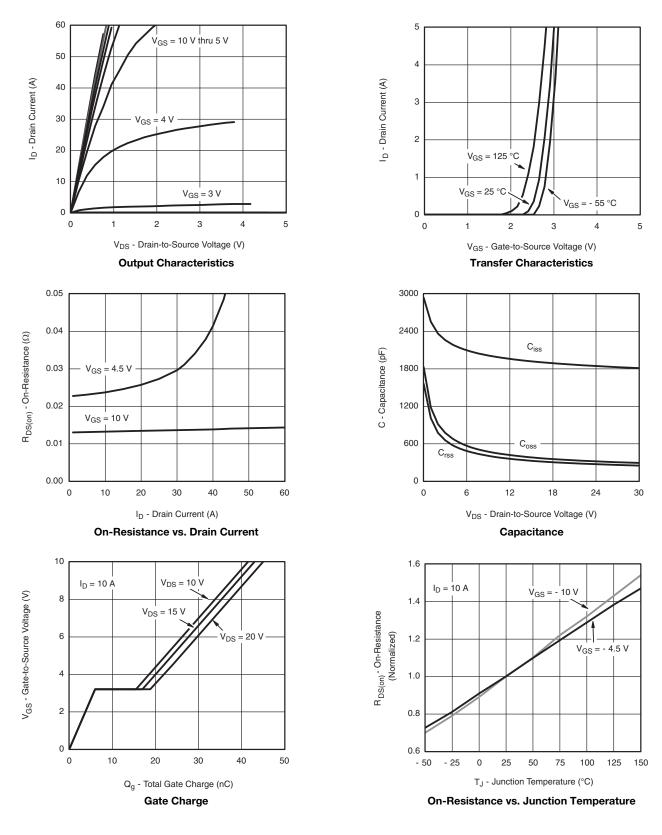
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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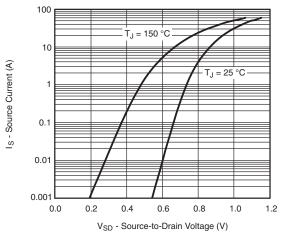
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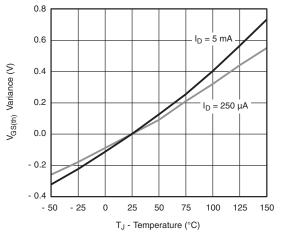
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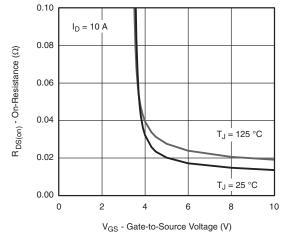
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



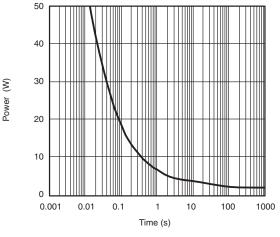
Source-Drain Diode Forward Voltage



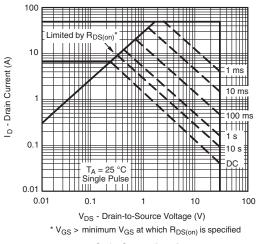




On-Resistance vs. Gate-to-Source Voltage







Safe Operating Area

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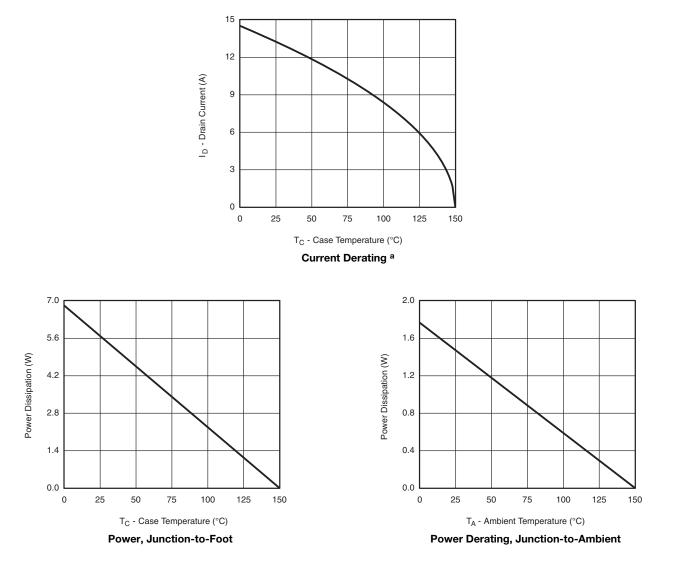
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Si4835DDY

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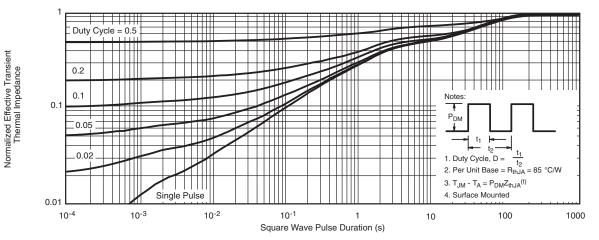


#### Note

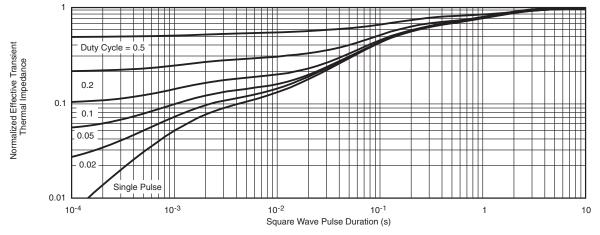
a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



**Vishay Siliconix** 



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?69953.

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## Package Information

Vishay Siliconix

# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIMETERS		INC	HES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

## **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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